

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUJI TAKAGI	07/20/2020
YUKO OTANI	07/28/2020
RECEIVING PARTY DATA	
Name:	HITACHI HIGH-TECH CORPORATION
Street Address:	1-17-1 TORANOMON
City:	MINATO-KU, TOKYO
State/Country:	JAPAN
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	16970451
CORRESPONDENCE DATA	
Fax Number:	(703)610-8686
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
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Address Line 1:	1751 PINNACLE DR.
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ATTORNEY DOCKET NUMBER:	T9094-23774US01
NAME OF SUBMITTER:	MADELIENE B. LEAHY
SIGNATURE:	/Madeliene B. Leahy/
DATE SIGNED:	08/17/2020
Total Attachments: 2	
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source=Assignment_-_T9094-23774US01#page2.tif	

ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

IN CONSIDERATION of the sum of One Dollar (\$1.00) or the equivalent thereof, and other good and valuable consideration paid to me citizen of Japan by Hitachi High-Tech Corporation
a corporation organized under the laws of Japan,
located at 1-17-1 Toranomom, Minato-ku, Tokyo, Japan
receipt of which is hereby acknowledged I do hereby sell and assign to said Hitachi High-Tech Corporation
its successor and assigns, all my right, title and interest, in and for the United States of America, in and to

DEFECT DETECTION DEVICE, DEFECT DETECTION METHOD, AND DEFECT OBSERVATION DEVICE

invented by me (if only one is named below) or us (if plural inventors are named below) and described in the
application for United States Letters Patent therefor, executed on even date herewith, and all United States Letters
Patent which may be granted therefor, and all divisions, continuations and extensions thereof, the said interest being
the entire ownership of the said Letters Patent when granted,
to be held and enjoyed by said Hitachi High-Tech Corporation
its successor, assigns or other legal representatives, to the full end of term for which said Letters Patent may be
granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale
had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and
proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing,
continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment,
extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said
Hitachi High-Tech Corporation

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) Yuji Takagi Yuji TAKAGI Jul. 20. 2020

2) _____ Yuko OTANI _____

ASSIGNMENT

(譲 渡 証)

As a below named inventor, I hereby declare that:

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to be held and enjoyed by said Hitachi High-Tech Corporation
its successor, assigns or other legal representatives, to the full end of term for which said Letters Patent may be granted as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said Hitachi High-Tech Corporation

Signed on the date(s) indicated aside our signatures:

INVENTOR(S)
(発明者フルネームサイン)

Date Signed
(署名日)

1) _____ Yuji TAKAGI

2) Yuko Otani _____ Yuko OTANI

Jul. 28. 2020